Filename:
 BOM-TIDA-00748(001)

 Variant:
 001

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60W Synchronous LED Driver

| Designator C !PCB C1 C2, C3, C4, C10 C5X | 1 1 | Value | Description Printed Circuit Board | PackageReference | PartNumber | Manufacturer | Alternate PartNumber | Alternate Manufacturer |
|--|--------|-----------------|---|---|-----------------------------------|-----------------------------|----------------------|------------------------|
| C1 C2, C3, C4, C10 | 1 | | | | TIDA-00784 | Any | | 1 |
| C10 | | 150pF | CAP, CERM, 150 pF, 100 V, +/- 5%, C0G/NP0, 0805 | 0805 | 08051A151JAT2A | AVX | | |
| | 4 | 3.3uF | CAP, CERM, 3.3uF, 50V, +/-10%, X7R, 1210 | 1210 | GRM32DR71H335KA88 | MuRata | -, -, -, [NoValue] | -, -, -, [NoValue] |
| | 1 | 330uF | CAP, OS-CON, 330 µF, 25 V, +/- 20%, 0.014 ohm, F12, SMD, 2-Leads, Body 10.5x10.5mm, Height | F12, SMD, 2-Leads, Body 10.5x10.5mm, | L 25SVPF330M | Sanyo | | |
| C6, C7, C8, | 4 | 330uF | 12.7mm SMD CAP, AL, 330 μF, 35 V, +/- 20%, 0.06 ohm, SMD | Height 12.7mm 10 x 10 | EEE-FP1V331AP | Panasonic | | |
| C9 C11, C13, | 3 | 10uF | CAP, CERM, 10 µF, 35 V, +/- 20%, X7R, 1210 | 1210 | GMK325AB7106MM-T | Taiyo Yuden | | |
| C14 C12 | 1 | 1uF | CAP, CERM, 1uF, 100V, +/-10%, X7R, 1210 | 1210 | GRM32CR72A105KA35 | MuRata | | |
| C15 | 1 | 0.1uF | | 0005 | L 08053C104KAT2A | AVX | | |
| C15 C16, C18, | 3 | 0.10F 100pF | CAP, CERM, 0.1uF, 25V, +/-10%, X7R, 0805 CAP, CERM, 100pF, 50V, +/-5%, C0G/NP0, 0603 | 0805 0603 | GRM1885C1H101JA01 | MuRata | - | - |
| C20 C17 | 1 | 4.7uF | CAP, CERM, 4.7uF, 16V, +/-10%, X7R, 0805 | 0805 | D GRM21BR71C475KA73 | MuRata | | - |
| - | | | | | L | | - | - |
| C19, C21 | 2 | 0.47uF | CAP, CERM, 0.47uF, 25V, +/-10%, X7R, 0603 | 0603 | GRM188R71E474KA12 D | MuRata | - | - |
| C22 | 1 | 0.1uF | CAP, CERM, 0.1 µF, 25 V, +/- 10%, X7R, 0603 | 0603 | 06033C104KAT2A | AVX | | |
| C23 | 1 | 470pF | CAP, CERM, 470 pF, 100 V, +/- 5%, X7R, 0603 | 0603 | 06031C471JAT2A | AVX | | |
| C24 | 1 | 0.22uF | CAP, CERM, 0.22 µF, 50 V, +/- 10%, X7R, 0805 | 0805 | C0805C224K5RACTU | Kemet | | |
| C25 | 1 | 0.22uF | CAP, CERM, 0.22 μF, 25 V, +/- 10%, X7R, 0805 | 0805 | 08053C224KAT2A | AVX Wurth Elektronik | | |
| C26 D1 | 1 | 4.7uF 0.77V | CAP, CERM, 4.7 µF, 10 V, +/- 10%, X7R, 0805 Diode, Schottky, 100V, 1A, PowerDI123 | 0805 PowerDI123 | 885012207025 DFLS1100-7 | Diodes Inc. | | |
| FID4, FID5, | 3 | 0.77V | Fiducial mark. There is nothing to buy or mount. | Fiducial | N/A | N/A | | |
| FID6 H1, H2, H3, | 4 | | Machine Screw, Round, #4-40 x 1/4, Nylon, Philips | Screw | NY PMS 440 0025 PH | B&F Fastener Supply | | |
| H4 H5, H6, H7, | 4 | | panhead Standoff, Hex, 0.5"L #4-40 Nylon | Standoff | 1902C | Keystone | | |
| H8 J1, J2, J3, | 5 | | Standard Banana Jack, Uninsulated, 5.5mm | Keystone_575-4 | 575-4 | Keystone | | |
| J4, J6 | | | | - | | - | | |
| J5 | 1 | 1x3 | Header, 100mil, 3x1, Gold, TH | PBC03SAAN | PBC03SAAN | Sullins Connector Solutions | | |
| L1 | 1 | 10uH | Inductor, Drum Core, Ferrite, 10uH, 21A, 0.0034 ohm, SMD | 22.5x12x20mm | 74435581000 | Wurth Elektronik eiSos | | |
| LBL1 | 1 | | Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll | PCB Label 0.650"H x 0.200"W | THT-14-423-10 | Brady | | |
| Q1, Q2 | 2 | 40V | MOSFET, N-CH, 40V, 22A, SON 5x6mm | SON 5x6mm | CSD18501Q5A | Texas Instruments | | None |
| Q100 | 1 | 40 V | Transistor, NPN, 40 V, 0.2 A, SOT-23 | SOT-23 | MMBT3904 | Fairchild Semiconductor | | |
| R1 | 1 | 4.7 | RES, 4.7 ohm, 5%, 1W, 2010 | 2010 | CRM2010-JW-4R7ELF | Bourns | | |
| R2 | 1 | 0.003 | RES, 0.003, 1%, 4 W, 3015 WIDE | 3015 WIDE | KRL7638-C-R003-F-T1 | Susumu Co Ltd | | |
| R3, R4 R5, R6, R7, R8, R12, | 2 6 | <u>100</u> 0 | RES, 100 ohm, 1%, 0.1W, 0603 RES, 0 ohm, 5%, 0.1W, 0603 | 0603 0603 | CRCW0603100RFKEA ERJ-3GEY0R00V | Vishay-Dale Panasonic | Equivalent - | Any - |
| R15 R9 | 1 | 32.4k | RES, 32.4 k, 0.1%, 0.1 W, 0603 | 0603 | RT0603BRD0732K4L | Yageo America | | |
| R10 | 1 | 2.2 | RES, 2.2 ohm, 5%, 0.125W, 0805 | 0805 | CRCW08052R20JNEA | Vishay-Dale | | |
| R11 | 1 | 124k | RES, 124 k, 1%, 0.1 W, 0603 | 0603 | CRCW0603124KFKEA | Vishay-Dale | | |
| R13 | 1 | 9.20k | RES, 9.20 k, 0.1%, 0.1 W, 0603 | 0603 | RT0603BRD079K2L | Yageo America | | |
| R14 | 1 | 64.2k | RES, 64.2 k, 0.1%, 0.1 W, 0603 | 0603 | RT0603BRD0764K2L | Yageo America | | |
| R16 | 1 | 50.5k | RES, 50.5 k, 0.1%, 0.1 W, 0603 | 0603 | RT0603BRD0750K5L | Yageo America | | |
| R17, R18, R21 | 3 | 10.0k | RES, 10.0 k, 1%, 0.1 W, 0603 | 0603 | CRCW060310K0FKEA | Vishay-Dale | | |
| R19 | 1 | 48.7 | RES, 48.7 ohm, 1%, 0.125W, 0805 | 0805 | CRCW080548R7FKEA | Vishay-Dale | | |
| R20 | 1 | 0.016 | RES, 0.016, 1%, 1 W, 2512 | 2512 | ERJ-M1WSF16MU | Panasonic | | |
| R101 | 1 | 348k | RES, 348 k, 0.1%, 0.1 W, 0603 | 0603 | RT0603BRD07348KL | Yageo America | | |
| R102 | 1 | 10.0k | RES, 10.0 k, 0.1%, 0.1 W, 0603 | 0603 | RT0603BRD0710KL | Yageo America | | |
| TP1, TP3, TP10 | 3 | Red | Test Point, Multipurpose, Red, TH | Red Multipurpose Testpoint | 5010 | Keystone | | |
| TP2, TP7, TP8 | 3 | White | Test Point, Multipurpose, White, TH | White Multipurpose Testpoint | 5012 | Keystone | | |
| TP4, TP5, TP9 | 3 | Black | Test Point, Multipurpose, Black, TH | Black Multipurpose Testpoint | 5011 | Keystone | | |
| TP6 | 1 | Yellow | Test Point, Compact, Yellow, TH | Yellow Compact Testpoint | 5009 | Keystone | | |
| U1 | 1 | | Wide Input Synchronous Boost Controller with Multiple Phase Capability | PWP0020A | LM5122-Q1 | Texas Instruments | - | - |
| U2 | 1 | | Voltage Output, High or Low Side Measurement, Bi- Directional Zerø-Drift Series Current-Shunt Monitor, DCK0006A | DCK0006A | INA199A1DCKR | Texas Instruments | INA199A1DCKT | Texas Instruments |
| FID1, FID2, FID3 | 0 | | Fiducial mark. There is nothing to buy or mount. | Fiducial | N/A | N/A | | |

Notes:

Unless otherwise noted in the Alternate PartNumber and/or Alternate Manufacturer columns, all parts may be substituted with equivalents.

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